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FDPF3N50NZ N-Channel UniFET[™] II MOSFET **500 V, 3 A, 2.5** Ω

Features

- R_{DS(on)} = 2.1 Ω (Typ.) @ V_{GS} = 10 V, I_D = 1.5 A
- Low Gate Charge (Typ. 6.2 nC)
- Low C_{rss} (Typ. 2.5 pF)
- 100% Avalanche Tested
- · Improved dv/dt Capability
- · ESD Improved Capability
- · RoHS Compliant

Applications

- · LCD/LED TV
- · Uninterruptible Power Supply



AC-DC Power Supply

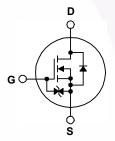




Description

UniFETTM II MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on advanced planar stripe and DMOS technology. This advanced MOSFET family has the smallest on-state resistance among the planar MOSFET, and also provides superior switching performance and higher avalanche energy strength. In addition, internal gate-source ESD diode allows UniFET II MOSFET to withstand over 2kV HBM surge stress. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

	Parameter		FDPF3N50NZ	Unit	
Drain to Source Voltag	Source Voltage		500	V	
Gate to Source Voltage	9		±25	V	
Drain Current	- Continuous (T _C = 25 ^o C)		3*		
Drain Current	- Continuous (T _C = 100 ^o C)	1.8*	— A	
Drain Current	- Pulsed	(Note 1)	12*	Α	
Single Pulsed Avalanc	he Energy	(Note 2)	113	mJ	
Avalanche Current		(Note 1)	3	Α	
Repetitive Avalanche Energy		(Note 1)	5.4	mJ	
Peak Diode Recovery	ak Diode Recovery dv/dt		10	V/ns	
Dower Dissinction	(T _C = 25°C)		27	W	
Power Dissipation	- Derate above 25°C		0.21	W/ºC	
Operating and Storage Temperature Range			-55 to +150	°C	
Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	
	Gate to Source Voltage Drain Current Drain Current Single Pulsed Avalance Avalanche Current Repetitive Avalanche E Peak Diode Recovery Power Dissipation Operating and Storage Maximum Lead Tempe	$\begin{tabular}{ c c c c } \hline Drain to Source Voltage & \hline & $	$ \begin{array}{c c c c c c c c c } \hline Drain to Source Voltage & & & & & \\ \hline Gate to Source Voltage & & & & \\ \hline Gate to Source Voltage & & & & \\ \hline Gate to Source Voltage & & & & \\ \hline Drain Current & & & & \\ \hline Prain Current & & & & \\ \hline Pulsed & (Note 1) & & \\ \hline Single Pulsed Avalanche Energy & & & & \\ \hline Avalanche Current & & & & \\ \hline Avalanche Current & & & & \\ \hline Note 1) & \\ \hline Repetitive Avalanche Energy & & & & \\ \hline Note 1) & \\ \hline Repetitive Avalanche Energy & & & & \\ \hline Note 1) & \\ \hline Peak Diode Recovery dv/dt & & & & \\ \hline Note 3) & & \\ \hline Power Dissipation & & & \\ \hline \hline Cr_C = 25^{\circ}C) & & \\ \hline - Derate above 25^{\circ}C & & \\ \hline Operating and Storage Temperature Range & \\ \hline Maximum Lead Temperature for Soldering Purpose, & & \\ \hline \end{array} $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	

Thermal Characteristics

Symbol	Parameter	FDPF3N50NZ	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	4.6	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W

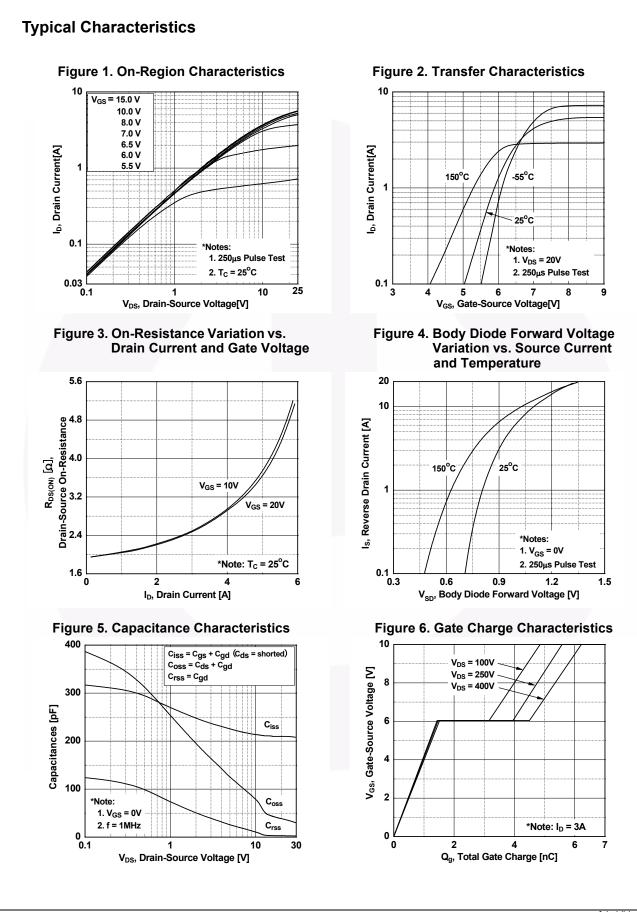
Device MarkingDevicePackFDPF3N50NZFDPF3N50NZTO-22		Pack	kage Reel Size Tape		Width		Quantit	у		
		•		I	N/A		50 units			
Electrica	l Char	acteristics ⊤ _c =	25°C unles	s otherwi	se noted					
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic	S					1			L
BV _{DSS}	Drain to	o Source Breakdown V	/oltage	In = 25	50μΑ, V _{GS} = 0V, T _C =	= 25°C	500	-	-	V
ΔBV_{DSS}		own Voltage Temperat	0				<u> </u>			
$/\Delta T_J$	Coeffic	U 1		$I_D = 28$	50µA, Referenced to	25°C	-	0.5	-	V/°C
1	Zoro G	ate Voltage Drain Curr	ont	V _{DS} = 500V, V _{GS} = 0V			-	-	1	
DSS	Zelo G	ale vollage Drain Curr	ent	V _{DS} =	400V, V _{GS} = 0V,T _C =	= 125°C	-	-	10	μA
I _{GSS}	Gate to	Body Leakage Currer	nt	V _{GS} =	±25V, V _{DS} = 0V		-	-	±10	μA
On Charac	teristic	s								
V _{GS(th)}	Gate T	hreshold Voltage		V _{GS} =	V _{DS} , I _D = 250μA		3.0	-	5.0	V
R _{DS(on)}		Static Drain to Source On Resistance			10V, I _D = 1.5A		-	2.1	2.5	Ω
9 _{FS}	Forwar	d Transconductance	-	00	20V, I _D = 1.5A		-	1.9	-	S
Dynamic C	Charact	eristics		1 -			1			
C _{iss}		apacitance					-	210	280	pF
C _{oss}	Output	t Capacitance		V _{DS} = 25V, V _{GS} = 0V f = 1MHz	-	30	45	pF		
C _{rss}	Revers	e Transfer Capacitanc	е	f = 1MHz		-	2.5	5	pF	
Q _{g(tot)}	Total G	ate Charge at 10V					-	6.2	9	nC
Q _{gs}	Gate to	Source Gate Charge		$V_{DS} = 400V I_D = 3A$ $V_{GS} = 10V$ (Note 4)		-	1.4	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge				-	3.1	-	nC	
Switching	Charac	teristics								
t _{d(on)}	Turn-On Delay Time		-				-	10	30	ns
t _r		n Rise Time		V_{DD} = 250V, I_D = 3A V_{GS} = 10V, R_{GEN} = 25 Ω		-	15	40	ns	
t _{d(off)}	Turn-Of	ff Delay Time				-	26	60	ns	
t _f	Turn-Of	ff Fall Time				(Note 4)	-	17	45	ns
	rce Dio	de Characteristic	·e			, ,				
I _S		m Continuous Drain to		de Forwa	rd Current		-	-	3	A
I _{SM}	Maximum Pulsed Drain to Source Diode		urce Diode F			-	-	12	Α	
V _{SD}	Drain to Source Diode Forward Voltage		d Voltage	V _{GS} = 0V, I _{SD} = 3A			-	-	1.4	V
t _{rr}	Reverse	e Recovery Time		V _{GS} =	0V, I _{SD} = 3A		-	190	-	ns
Q _{rr}	-	e Recovery Charge		$v_{GS} = 00, i_{SD} = 3A$ $dI_{F}/dt = 100A/\mu s$		-	0.52	-	μC	

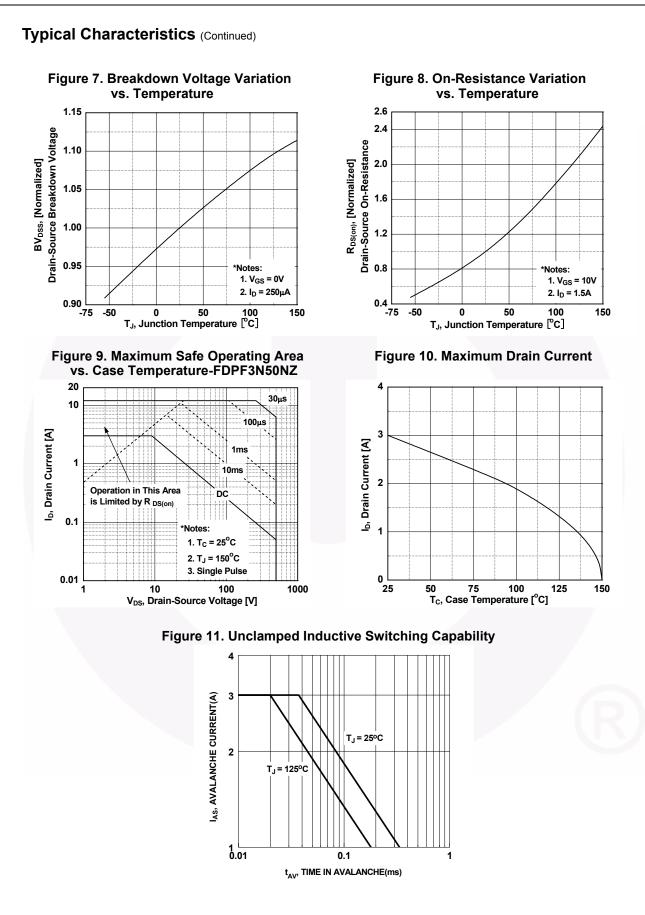
2. L = 25mH, I_{AS} = 3A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

3. I_{SD} \leq 3A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

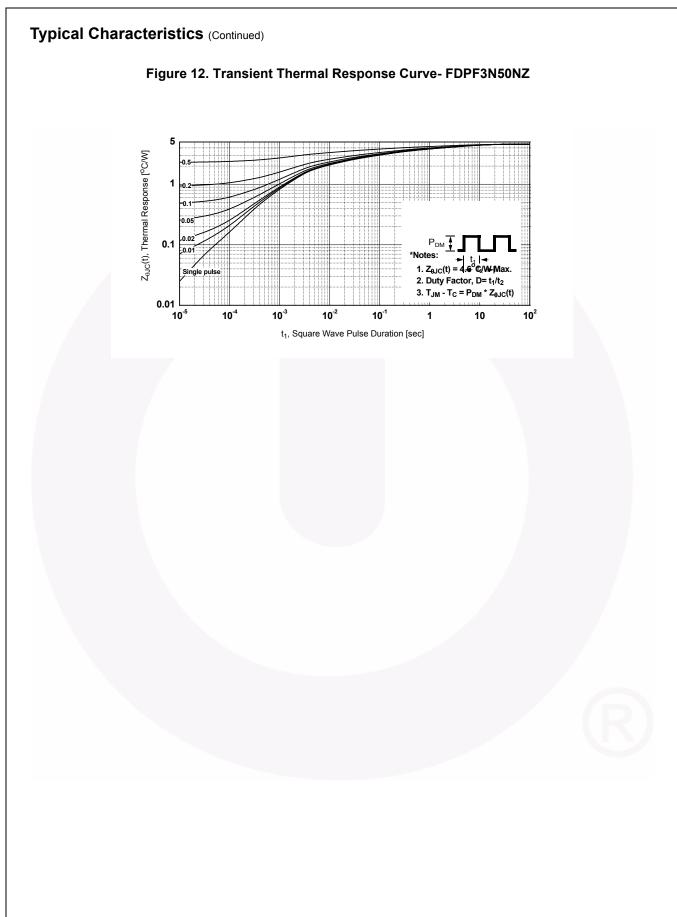
4. Essentially Independent of Operating Temperature Typical Characteristics

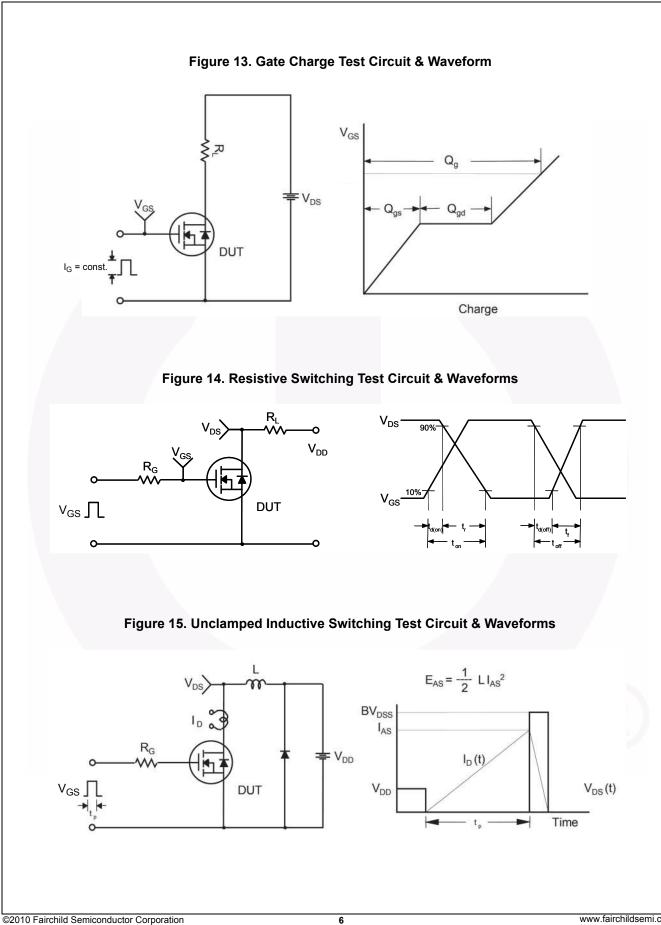
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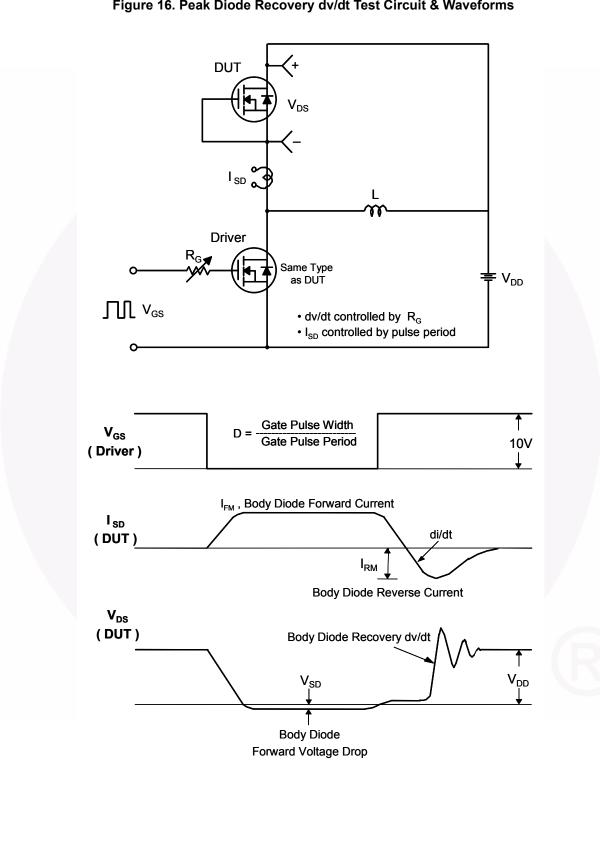
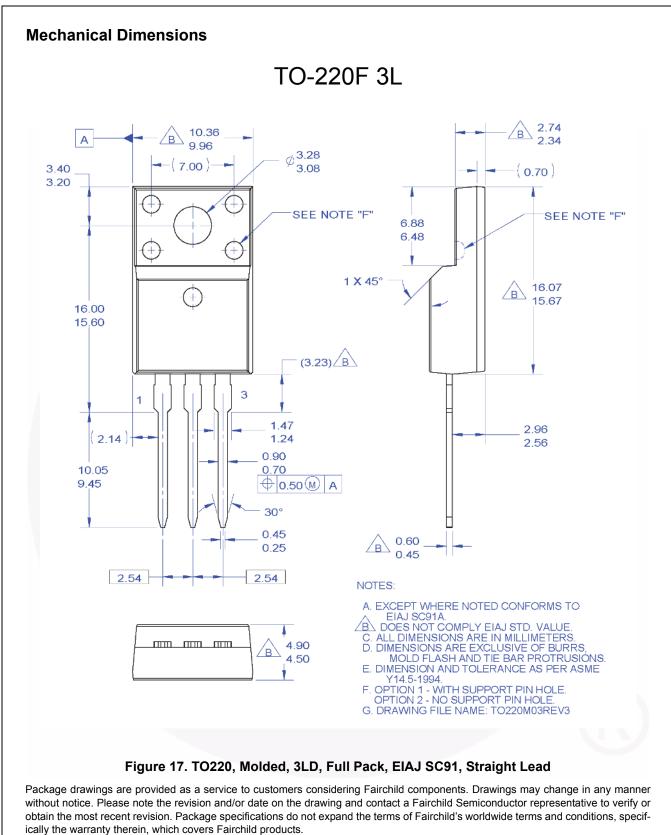


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms



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Dimension in Millimeters

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